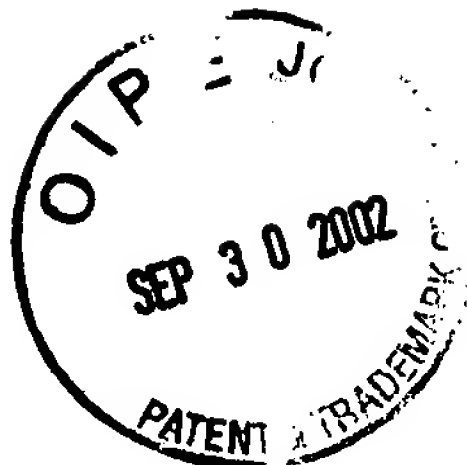


Docket No. IRV1.PAU.53



Pat nt Application

7
Election
w/a
10-7-02
over

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Angel Antonio Pepe, et al.

Serial No.: 09/938,686

Filed: October 30, 2001

For: STACKABLE LAYERS
CONTAINING ENCAPSULATED
INTEGRATED CIRCUIT CHIPS
WITH ONE OR MORE
OVERLYING INTERCONNECT
LAYERS AND A METHOD OF
MAKING THE SAME

Examiner: Nguyen, Cuong Quang

Group Art Unit: 2811

Irvine, California

September 25, 2002

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AMENDMENT "A"

Assistant Commissioner for Patents
Washington, D.C. 20231

Dear Sir:

Please enter the following amendment in response to the Office Action
dated August 27, 2002.

In the Claims

Please cancel Claims 17-32 directed to a semiconductor device without
prejudice. Applicants may elect to prosecute such claims in a divisional application.

Claims 1-16 that remain in this application after Claims 17-32 are
canceled as shown in the attached Appendix appear in clean form as follows: